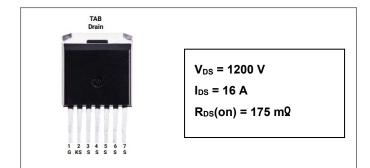


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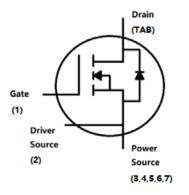
S2M0160120J

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S2M0160120J 1200V SIC POWER MOSFET



Circuit Diagram



Description

S2M0160120J is single SiC Power MOSFET packaged in TO-263-7 case. The device is a high voltage n-channel enhancement mode MOSFET that has very low total conduction losses and very stable switching characteristics over temperature extremes. The S2M0160120J is ideal for energy sensitive, high frequency applications in challenging environments.

Features

- Positive temperature characteristics, easy to parallel.
- Low on-resistance Typ. RDS(on) = 175mΩ .
- Fast switching speed and low switching losses.
- Very fast and robust intrinsic body diode.
- Process of non-bright Tin electroplatin

Applications

- EV Fast Charging Modules
- EV On Board Chargers
- Solar Inverters
- Online UPS/Industrial UPS
- SMPS (Switch Mode Power Supplies)
- DC-DC Converters
- ESS (Energy Storage Systems)

Characteristics Symbol Condition Units Max. 1200 V Drain Source Voltage VDSS $V_{GS} = 0V, I_{DS} = 100uA, T_{C} = 25^{\circ}C$ Gate Source Voltage V_{GSS} T_c = 25 ° C, Absolute maximum values, AC -10 to +25 V (f>1Hz) Gate Source Voltage -5 to +20 V VGSOP T_c = 25°C Recommended Operational Values **Continuous Drain Current** $V_{GS} = 20V, T_C = 25^{\circ}C$ ΙD 16 А I_D $V_{GS} = 20V, T_{C} = 100^{\circ}C$ 11 А Tc=25°C 40 Pulsed Drain Current А ID,pulse T_c=25°C 122 Power Dissipation P_{D} W

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Maximum Ratings(T=25°C unless otherwise specified)



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Electrical Characteristics(T=25℃ unless otherwise specified)

Characteristics	Symbol	Condition	Min.	Тур.	Max.	Units	
Drain Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 100 uA	1200			V	
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 2.5 \text{ mA}$	2.0	2.8	4	V	
		V_{DS} = V_{GS} , I_D = 2.5 mA, T_J = 175 °C		1.9		V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 1200 V, V _{GS} = 0 V		1	100	uA	
Gate Source Leakage Current	I _{GSS}	V _{GS} = 20 V, V _{DS} = 0 V			250	nA	
Drain Source On-State Resistance	R _{DS(on)}	V _{GS} = 20 V, I _D = 10 A		175	196	mΩ	
		V _{GS} = 20 V, I _D = 10 A, T _J = 175 °C		300		mΩ	
Transconductance	gfs	V _{DS} = 20 V, I _D = 10 A		3.3		s	
		V _{DS} = 20 V, I _D = 10 A, T _J = 175 °C		3.4		s	
Input Capacitance	C _{ISS}	V _{GS} = 0 V,		513		pF	
Output Capacitance	Coss	V _{DS} = 1000 V		35.6			
Reverse Transfer Capacitance	Crss	V _{AC} = 25 mV f = 100 kHz		2.59			
Coss Stored Energy	Eoss			20.5		uJ	
Turn-On Switching Energy	E _{ON}	V_{DS} = 800 V, V_{GS} = -5/+20 V		90.3		– uJ	
Turn-Off Switching Energy	E _{OFF}	ID =10 A, RG(ext)=2.5 Ω		54.5			
Turn-On Delay Time	$t_{d(on)}$			3.5			
Rise Time	tr			11.8			
Turn-Off Delay Time	$t_{d(off)}$	V _{DS} = 800 V, V _{GS} = -5/20 V I _D = 10 A, R _{G(ext)} = 2.5 Ω, R _L =80 Ω		7.0		ns	
Fall Time	t _f			13.4			
Internal Gate Resistance	R _{G(int)}	f = 1 MHz, VAC = 25 mV, D-S short		6.5		Ω	
Gate to Source Charge	Q _{gs}	V _{DS} = 800 V, V _{GS} = -5/20 V		7.7			
Gate to Drain Charge	Q_{gd}	I _D = 10 A		8.2		nC	
Total Gate Charge	Qg			26.5			



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Reverse Diode Characteristics:

Characteristics	Symbol	Condition	Тур.	Max.	Units
Diode Forward Voltage	V _{SD}	V _{GS} = -5 V, I _{SD} = 5 A	3.3		V
	V _{SD}	V _{GS} = -5 V, I _{SD} = 5 A, T _J = 175 °C	2.9		V
Continuous Diode Forward Current	ls	V _{GS} = -5 ∨, T _C = 25 ℃	20		А
Reverse Recovery Time	t _{rr}	V _{GS} = -5 V, I _{SD} = 10 A, T _J = 25 °C	6.6		ns
Reverse Recovery Charge	Qrr	V _R = 800 V	0.04		uC
Peak Reverse Recovery Current	I _{mm}	dif/dt= 2533 A/µs	11		А

Thermal-Mechanical Specifications:

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +175	°C
Storage Temperature	T _{stg}	-	-55 to +175	°C
Typical Thermal Resistance Junction to Case	$R_{ ext{ heta}JC}$	DC operation	1.23	°C/W
Maximum Thermal Resistance Junction to Ambient	R _{0JA}		40	°C/W

Ordering Information:

Device	Package	Shipping	
S2M0160120JTR	TO-263-7	800pcs/reel	
S2M0160120J	TO-263-7	50pcs/tube	

Marking Diagram



Where XXXXX is YYWWL

S2M = Device Type 0160

- = R_{DS}(on) 120 = Reverse Voltage (1200V)
 - = Package
- SSG = SSG YΥ

J

1

- = Year = Week
- WW = Lot Number

Cautions: Molding resin Epoxy resin UL:94V-0

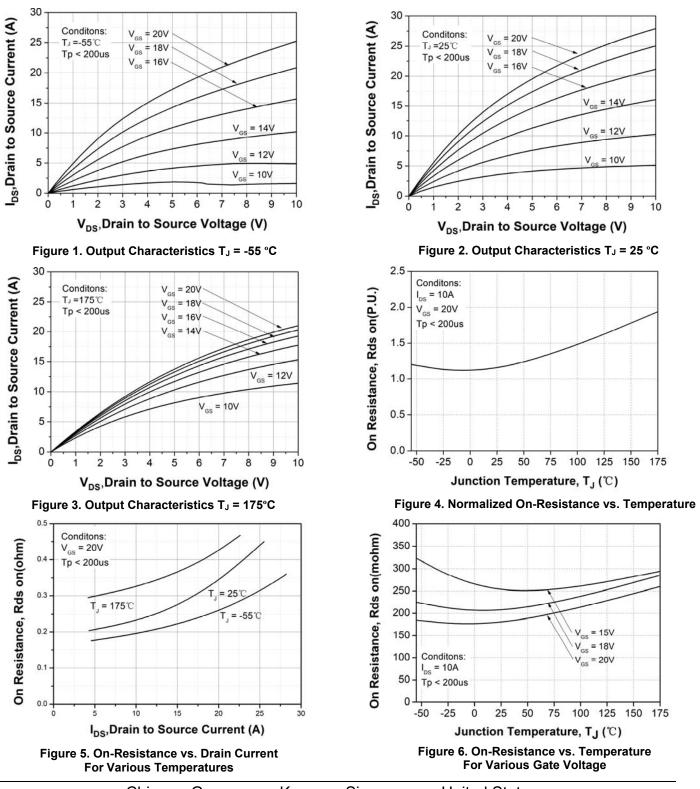
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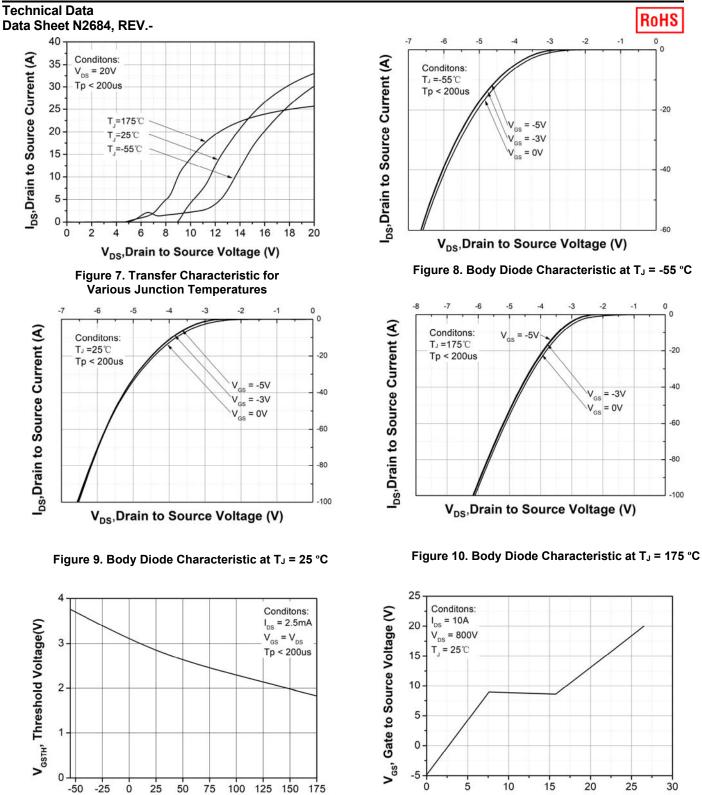
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Ratings and Characteristics Curves



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Junction Temperature, T_J (℃)

Figure 12. Gate Charge Characteristic

Q_c, Gate Charge (nC)

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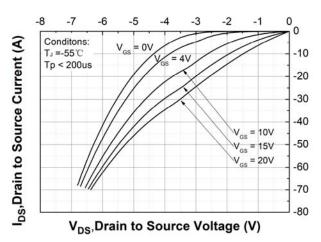
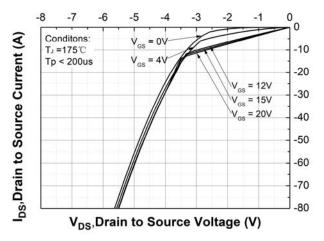
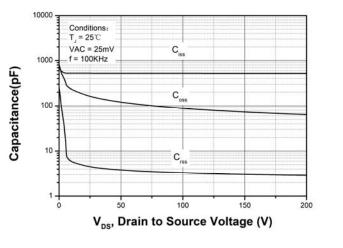
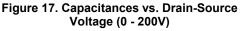


Figure 13. 3rd Quadrant Characteristic at $T_J = -55 \ ^{\circ}C$









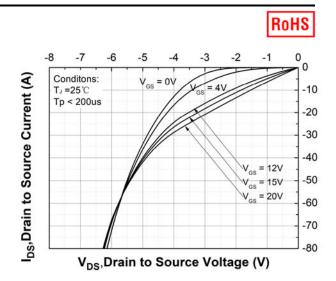


Figure 14. 3rd Quadrant Characteristic at T_J = 25 °C

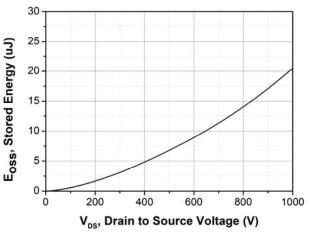


Figure 16. Output Capacitor Stored Energy

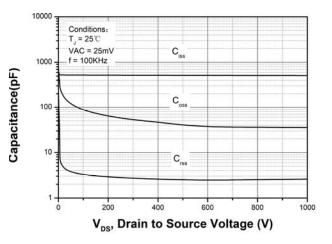
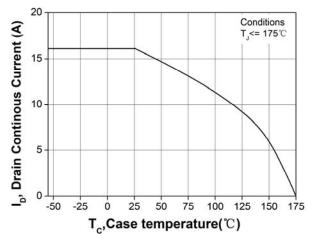


Figure 18. Capacitances vs. Drain-Source Voltage (0 - 1000V)

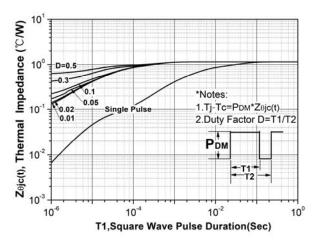
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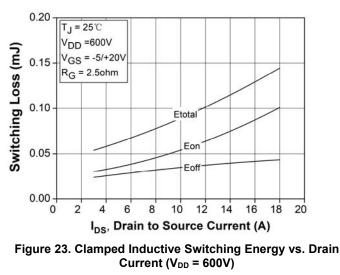
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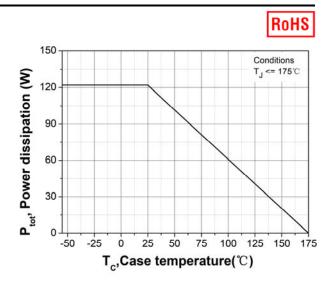
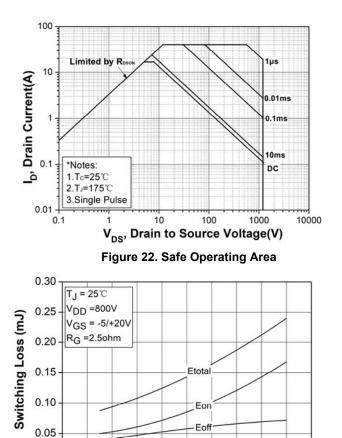
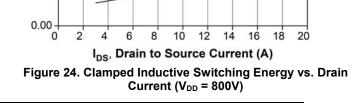


Figure 20. Maximum Power Dissipation Derating vs. Case Temperature





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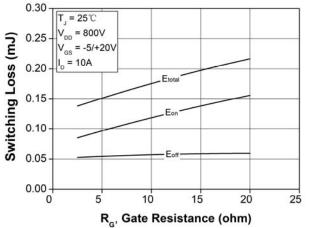


Figure 25. Clamped Inductive Switching Energy vs. R_{G(ext)}

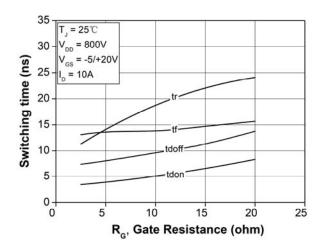
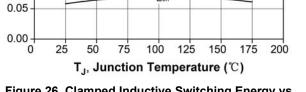


Figure 27. Switching Times vs. R_{G(ext)}



0.30

0.25

0.20

0.15

0.10

Switching Loss (mJ)

R

GS

= 10A

= 2.50hm

= 800V

= -5/+20V

Figure 26. Clamped Inductive Switching Energy vs. Temperature

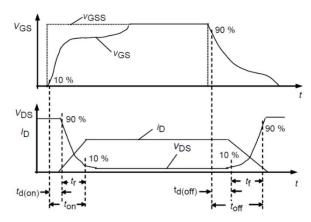


Figure 28. Switching Times Definition





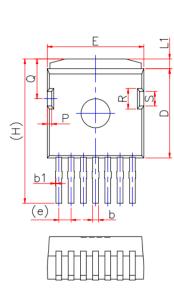
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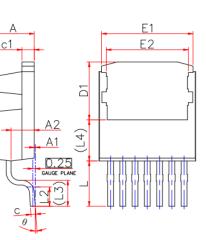


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Mechanical Dimensions TO-263-7





SYMBOL	Millimeters				
STMBOL	TYP.	MAX.	MIN		
Α	4.3	4.4	4.5		
A1	0	0.1	0.2		
A2	2.3	2.4	2.5		
b	0.5	0.6	0.7		
b1	0	0.075	0.15		
с	0.4	0.5	0.6		
c1	1.17	1.27	1.37		
D	9.05	9.25	9.45		
D1	5.9	6	6.1		
E	9.8	10	10.2		
E1	9.36	9.46	9.56		
E2	8.4	8.5	8.6		
е	1.270 REF				
Н	15.000 REF				
L	4.2	4.7	5.2		
L1	0.7	1	1.3		
L2	1.7	2	2.3		
L3	2.700 REF				
L4	4.250 REF				
Р	0.35	0.45	0.55		
Q	4.02	4.12	4.22		
R	2.03	2.13	2.23		
S	1.4	1.5	1.6		
θ	4°	8°	0°		



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